# Modeling the Electric Double Layer in Finite Electrolyte Solutions

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**INTRODUCTION**: Electric double layers (EDLs) play a crucial role in many biophysical processes involving charged molecules (*e.g.* proteins, DNA), but are often a limiting factor in technological applications where charged conductors are brought in contact with electrolyte solutions. They form when charges in the conductor's surface layer (source charges) attract oppositely charged ionic species, which, in turn, modifies the electrostatic

**PROBLEM**: The implicit assumption that the reference potentials  $\phi_i^*$  are the same for all ionic species ("bottomless bulk") leads to unrealistic results when the number of source charges is no longer small compared to the number of ionic charges (*i.e.* high applied potentials, low solution volumes, and/or low ion concentrations).

**COMPUTATIONAL METHODS**: To avoid this problem, we use the accurate charge density for a binary, symmetric

## field generated by the source charges alone.



Figure 1. Simple EDL models. The Helmholtz model (left) assumes a compact layer of tightly bound counterions, while the Gouy-Chapman model (right) predicts a diffuse layer of counterions in solution.

## **POISSON-BOLTZMANN (PB) THEORY**: Assuming a **Boltzmann** distribution, the particle density for ionic species *i* at distance z from a planar electrode at potential $\phi_0$ is

where 
$$m_i(z) = n_i^* \exp\left(-\frac{\nu_i e_0[\phi(z) - \phi_i^*]}{kT}\right),$$
$$\phi_i^* = -\frac{kT}{\nu_i e_0} \ln\left[\frac{1}{d}\int_0^d \exp\left(-\frac{\nu_i e_0\phi(z)}{kT}\right)dz\right]$$

electrolyte

$$\rho(z) = \sum_{i} \nu_{i} e_{0} n^{*} \exp\left(-\frac{\nu_{i} e_{0}[\phi(z) - \phi_{i}^{*}]}{kT}\right),$$

which can be rewritten as

where

$$\rho(z) = n^* \nu e_0 d \left[ \frac{e^{-u(z)}}{Z_{\oplus}} - \frac{e^{+u(z)}}{Z_{\ominus}} \right]$$
$$Z_+ = \int_0^d e^{\mp u(z)} dz.$$

These last two equations were used in the **Electrostatics module** (*es*) and solved in COMSOL Multiphysics<sup>®</sup>.



0.1 V

- bulk (average) ion density  $n_i^*$
- ion valency  $\nu_i$
- elementary charge  $e_0$
- electrostatic potential at distance z  $\phi(z)$
- electrostatic potential where  $n_i(z) = n_i^*$  $\phi_i^*$
- Boltzmann constant k
- Tabsolute temperate
- thickness of solution layer d

## **GOUY-CHAPMAN (GC) THEORY:**

- binary, symmetric electrolyte:  $v_{\oplus} = -v_{\ominus} = v$  $n_{\oplus}^* = n_{\ominus}^* = n^*$
- $n_i(z) = n_i^*$  at same z for all ionic species ("bulk")  $\Rightarrow \phi_i^* = \phi_i^* = \dots = \phi^*$ , usually set to 0.

Inserting the charge density

$$\rho(z) = \sum_{i} \nu_i e_0 n^* \exp\left(-\frac{\nu_i e_0[\phi(z) - \phi^*]}{kT}\right)$$

Figure 2. Bottom electrode. Uncoated area: glass; thickness of metal coating (Au/Pd): 5 nm.

### **Figure 4** (above). Penetration of the electrostatic field into the solution with increasing applied potential.

**Figure 5** (right). Ion concentration profiles at different applied potentials.

**Figure 3**. Model geometry (2D axisym.) and electrostatic potential in 10<sup>-4</sup> M electrolyte at 20 °C (bottom electrode: 0.2 V; top: 0 V). Charge density on glass surface: 5000  $e_0/\mu m^2$ .



into Poisson's equation  $\nabla^2 \phi = -\rho/\epsilon$  leads to GC equation:

$$\frac{d^2\phi}{dz^2} = \frac{2n^*\nu e_0}{\epsilon} \sinh\frac{\nu e_0(\phi - \phi^*)}{kT}$$

**Analytical solution**:



reciprocal Debye length  $\kappa = [2n^*\nu^2 e_0^2/(\epsilon kT)]^{1/2}$ 

**CONCLUSIONS**: In many cases of interest, such as in microfluidic device applications, the approximation of a "bottomless bulk" solution is not justified, and the classical GC equations fail to adequately describe the EDL. In these cases, *finite* GC theory must be employed using numerical simulations.

## **REFERENCES**:

David J. Griffiths, Introduction to Electrodynamics, 2nd ed., Prentice Hall, New Jersey (1989) J. Baker-Jarvis, B. Riddle, and A. M. Young, IEEE Transaction on Dielectrics and Electrical Insulation 6 226, (1999)

Excerpt from the Proceedings of the 2018 COMSOL Conference in Boston